


**CERTIFICATE OF ELECTRONIC  
TRANSMISSION**

I hereby certify that this correspondence for Application No. 10/555,713 is being electronically transmitted to Technology Center 2894, via EFS-WEB, on December 21, 2010.

  
David H. Brinkman, Reg. No. 40,532

12/21/10  
Date

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants : Martin Hausner et al.  
Serial No. : 10/555,713  
Filed : October 20, 2006  
Confirmation No. : 9725  
Group Art Unit : 2894  
Examiner : Pham, Thanh V.  
Title : **RADIATION SENSOR, WAFER, SENSOR MODULE AND  
METHOD FOR MANUFACTURING A RADIATION SENSOR**  
Attorney Docket No. : BEET-14

Cincinnati, Ohio 45202

December 21, 2010

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**SUPPLEMENTAL AFTER FINAL AMENDMENT**

In response to the Office Action mailed on July 23, 2010 and the Advisory Action mailed on December 1, 2010, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.